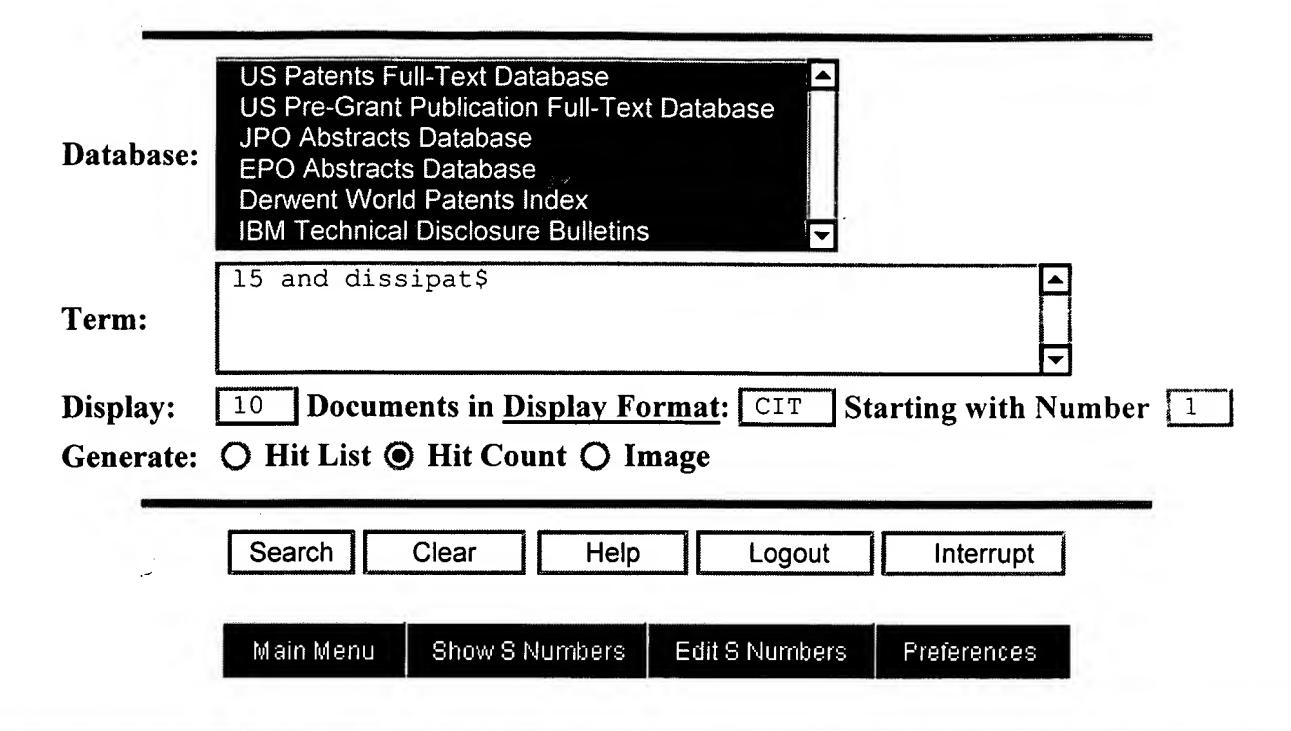
WEST

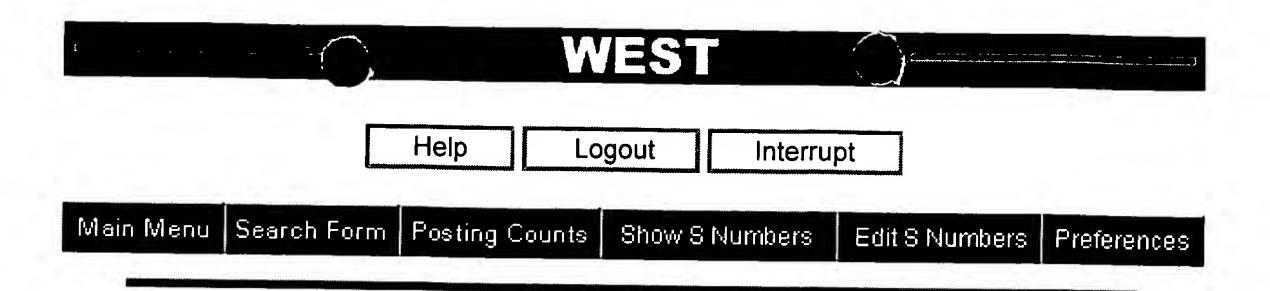
Freeform Search



Search History

Today's Date: 7/20/2001

DB Name	Query	<u>Hit</u> Count	<u>Set</u> <u>Name</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	15 and dissipat\$	27	<u>L6</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(bond near (tool or tip or capillary)) and (metal or conduct) and (ceramic or semiconducting or insulating or insulative or insulator or dielectric)	210	<u>L5</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	11 and (bond near (tool or tip or capillary))	0	<u>L4</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	12 and (bond near (tool or tip or capillary))	0	<u>L3</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	11 and (semiconductor or ceramic)	69	<u>L2</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(electric or electronic) near (dissipate or dissipative)	269	<u>L1</u>



Search Results -

Terms	Documents
bond (tool or tip or capillary or foot) and (semiconduct or semiconductor) and (titanium and carbide and nitride)	. 5

US Patents Full-Text Database
US Pre-Grant Publication Full-Text Database
JPO Abstracts Database
EPO Abstracts Database
Derwent World Patents Index
IBM Technical Disclosure Bulletins

Database:

bond (tool or tip or capillary or foot) and (semiconduct or semiconductor) and (titanium and carbide and nitride)

Search History

Clear

Today's Date: 7/20/2001

Refine Search:

DB Name	Query	<u>Hit</u> Count	Set Name
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	bond (tool or tip or capillary or foot) and (semiconduct or semiconductor) and (titanium and carbide and nitride)	5	<u>L2</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	bond (tool or tip or capillary or foot) and (dissipate or dissipative)	12	<u>L1</u>